



RF Chokes

Series/Type: B78148T, B78108T

The following products presented in this data sheet are being withdrawn.

Ordering Code	Substitute Product	Date of Withdrawal	Deadline Last Orders	Last Shipments
B78148T3821K009		2012-10-19	2013-01-31	2013-04-30
B78148T3821K000		2012-10-19	2013-01-31	2013-04-30
B78148T3681K009		2012-10-19	2013-01-31	2013-04-30



Ordering Code	Substitute Product	Date of Withdrawal	Deadline Last Orders	Last Shipments
B78148T3681K000		2012-10-19	2013-01-31	2013-04-30
B78148T3561K009		2012-10-19	2013-01-31	2013-04-30
B78148T3561K000		2012-10-19	2013-01-31	2013-04-30
B78148T3471K009		2012-10-19	2013-01-31	2013-04-30
B78148T3471K000		2012-10-19	2013-01-31	2013-04-30
B78148T3391K009		2012-10-19	2013-01-31	2013-04-30
B78148T3391K000		2012-10-19	2013-01-31	2013-04-30
B78148T3331K009		2012-10-19	2013-01-31	2013-04-30
B78148T3331K000		2012-10-19	2013-01-31	2013-04-30
B78148T3271K009		2012-10-19	2013-01-31	2013-04-30
B78148T3271K000		2012-10-19	2013-01-31	2013-04-30
B78148T3221K009		2012-10-19	2013-01-31	2013-04-30
B78148T3221K000		2012-10-19	2013-01-31	2013-04-30
B78148T3181K009		2012-10-19	2013-01-31	2013-04-30
B78148T3181K000		2012-10-19	2013-01-31	2013-04-30
B78148T3151K009		2012-10-19	2013-01-31	2013-04-30
B78148T3151K000		2012-10-19	2013-01-31	2013-04-30
B78148T3121K009		2012-10-19	2013-01-31	2013-04-30
B78148T3121K000		2012-10-19	2013-01-31	2013-04-30
B78148T3101K009		2012-10-19	2013-01-31	2013-04-30
B78148T3101K000		2012-10-19	2013-01-31	2013-04-30
B78108T3821K009		2012-10-19	2013-01-31	2013-04-30
B78108T3821K000		2012-10-19	2013-01-31	2013-04-30
B78108T3681K009		2012-10-19	2013-01-31	2013-04-30
B78108T3681K000		2012-10-19	2013-01-31	2013-04-30
B78108T3561K009		2012-10-19	2013-01-31	2013-04-30
B78108T3561K000		2012-10-19	2013-01-31	2013-04-30
B78108T3471K009		2012-10-19	2013-01-31	2013-04-30
B78108T3471K000		2012-10-19	2013-01-31	2013-04-30
B78108T3391K009		2012-10-19	2013-01-31	2013-04-30
B78108T3391K000		2012-10-19	2013-01-31	2013-04-30
B78108T3331K009		2012-10-19	2013-01-31	2013-04-30
B78108T3331K000		2012-10-19	2013-01-31	2013-04-30
B78108T3271K009		2012-10-19	2013-01-31	2013-04-30
B78108T3271K000		2012-10-19	2013-01-31	2013-04-30
B78108T3221K009		2012-10-19	2013-01-31	2013-04-30
B78108T3221K000		2012-10-19	2013-01-31	2013-04-30
B78108T3181K009		2012-10-19	2013-01-31	2013-04-30



Ordering Code	Substitute Product	Date of Withdrawal	Deadline Last Orders	Last Shipments
B78108T3181K000		2012-10-19	2013-01-31	2013-04-30
B78108T3151K009		2012-10-19	2013-01-31	2013-04-30
B78108T3151K000		2012-10-19	2013-01-31	2013-04-30
B78108T3121K009		2012-10-19	2013-01-31	2013-04-30
B78108T3121K000		2012-10-19	2013-01-31	2013-04-30
B78108T3101K009		2012-10-19	2013-01-31	2013-04-30
B78108T3101K000		2012-10-19	2013-01-31	2013-04-30

For further information please contact your nearest EPCOS sales office, which will also support you in selecting a suitable substitute. The addresses of our worldwide sales network are presented at www.epcos.com/sales.

MCC choke (Mini Cylinder Core)
Rated inductance 0.1 ... 100 μ H
Rated current 85 ... 1120 mA
Construction

- Ceramic or ferrite cylinder core
- Winding: enamel copper wire
- Flame-retardant lacquer coating

Features

- Low total height
- Low inductance
- High resonance frequency
- Suitable for wave soldering
- RoHS-compatible

Applications

- RF blocking
- Decoupling and interference suppression
- For antenna systems, automotive electronics, telecommunications, entertainment electronics

Terminals

- Central axial leads (B78108T)
- Radially bent to 5 mm lead spacing (B78148T)
- B781*T3:
 - Base material Staku 30/copper-clad steel 30
 - Hot-dipped and electro-plated with pure tin
- B781*T1:
 - Base material CuAg0.1
 - Electroplated with nickel and pure tin

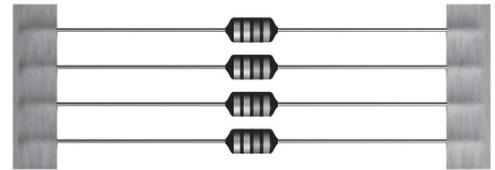
Marking

Inductance indicated by color bands to IEC 60062

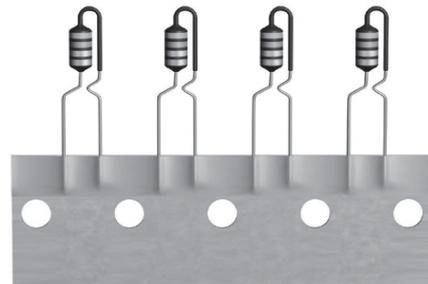
Delivery mode and packing units

- Taped, Ammo and reel packing
- Packing units:

	Ammo (pcs./pack.)	Reel (pcs./reel)
Axial	5000	5000
Radial	2500	2000



B78108T



B78148T

Technical data and measuring conditions

Rated inductance L_R	Measured with LCR meter Agilent 4284A or impedance analyzer Agilent 4294A Measuring frequency: $L_R \leq 10 \mu\text{H}$ = 1 MHz $10 \mu\text{H} < L_R \leq 4700 \mu\text{H}$ = 100 kHz Measuring current: $\leq 1 \text{ mA}$ Measuring temperature: +20 °C
Q factor Q_{\min}	Measured with precision impedance analyzer Agilent 4294A, +20 °C
Rated temperature T_R	+40 °C
Rated current I_R	Maximum permissible DC current at rated temperature
Inductance decrease $\Delta L/L_0$	$\leq 10\%$ (referred to initial value) at I_R , +20 °C
DC resistance R_{\max}	Measured at +20 °C
Resonance frequency $f_{\text{res},\min}$	Measured with Agilent 4294A or 8753ES, +20 °C
Solderability (lead-free)	Sn95.5Ag3.8Cu0.7: +(245 ±5) °C, (3 ±0.3) s Wetting of soldering area $\geq 90\%$ (to IEC 60068-2-20, test Ta)
Resistance to soldering heat	+(260 ±5) °C, 10 s (to IEC 60068-2-20, test Tb)
Tensile strength of leads	$\geq 20 \text{ N}$ (to IEC 60068-2-21, test Ua)
Climatic category	55/125/56 (to IEC 60068-1)
Storage conditions	Mounted: -55 °C ... +125 °C Packaged: -25 °C ... +40 °C, $\leq 75\%$ RH
Weight	Approx. 0.25 g

 Mounting information

When bending the leads, take care that the start-of-winding areas at the face ends (protected by glue and lacquer) are not subjected to any mechanical stress.

Characteristics and ordering codes

L_R μH	Tolerance ¹⁾	Q_{\min}	f_Q MHz	I_R mA	R_{\max} Ω	$f_{\text{res,min}}$ MHz	Ordering code ²⁾ (reel packing) ³⁾
Ceramic cylinder core							
0.10	$\pm 10\% \triangle K$	40	25.2	1120	0.13	600	B781*8T3101K000
0.12		40	25.2	1080	0.145	570	B781*8T3121K000
0.15		38	25.2	1020	0.155	500	B781*8T3151K000
0.18		35	25.2	1000	0.17	460	B781*8T3181K000
0.22		35	25.2	990	0.195	420	B781*8T3221K000
0.27		35	25.2	910	0.215	380	B781*8T3271K000
0.33		35	25.2	830	0.24	330	B781*8T3331K000
0.39		35	25.2	790	0.27	300	B781*8T3391K000
0.47		35	25.2	750	0.315	280	B781*8T3471K000
0.56		35	25.2	700	0.34	260	B781*8T3561K000
0.68		35	25.2	530	0.48	240	B781*8T3681K000
0.82		35	25.2	500	0.55	230	B781*8T3821K000

1) Closer tolerances on request.

2) Replace the * by code number »0« for axial taping or by »4« for radial taping.

3) For Ammo pack the last digit has to be a »9«. Example: B78108T3101K009

Characteristics and ordering codes

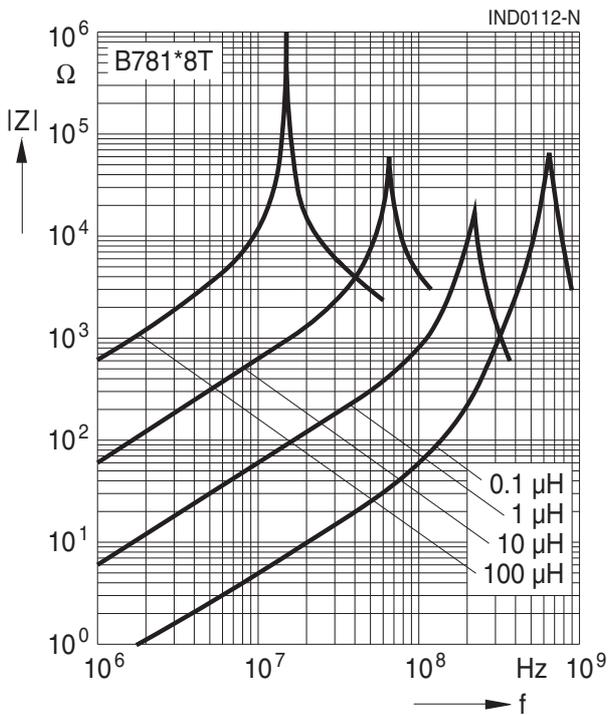
L_R μH	Tolerance ¹⁾	Q_{\min}	f_Q MHz	I_R mA	R_{\max} Ω	$f_{\text{res,min}}$ MHz	Ordering code ²⁾ (reel packing) ³⁾
Ferrite cylinder core							
1.0	$\pm 10\% \triangleq K$	35	25.2	630	0.25	180	B781*8T1102K000
1.2		40	7.96	610	0.25	170	B781*8T1122K000
1.5		40	7.96	570	0.30	150	B781*8T1152K000
1.8		40	7.96	540	0.30	130	B781*8T1182K000
2.2		40	7.96	520	0.35	120	B781*8T1222K000
2.7		40	7.96	480	0.40	110	B781*8T1272K000
3.3		40	7.96	420	0.50	110	B781*8T1332K000
3.9		40	7.96	400	0.55	100	B781*8T1392K000
4.7		40	7.96	380	0.65	90	B781*8T1472K000
5.6		45	7.96	260	1.30	75	B781*8T1562K000
6.8	45	7.96	250	1.45	70	B781*8T1682K000	
8.2	50	7.96	240	1.60	65	B781*8T1822K000	
10	50	7.96	230	1.70	60	B781*8T1103K000	
12	55	2.52	190	2.40	50	B781*8T1123K000	
15	55	2.52	185	2.70	45	B781*8T1153K000	
18	55	2.52	175	2.90	40	B781*8T1183K000	
22	60	2.52	170	3.20	30	B781*8T1223K000	
27	60	2.52	160	3.60	27	B781*8T1273K000	
33	60	2.52	150	4.10	24	B781*8T1333K000	
39	60	2.52	140	4.50	22	B781*8T1393K000	
47	60	2.52	100	8.50	20	B781*8T1473K000	
56	60	2.52	100	8.80	18	B781*8T1563K000	
68	60	2.52	95	10.0	15	B781*8T1683K000	
82	60	2.52	90	11.5	14	B781*8T1823K000	
100	60	2.52	85	12.5	11	B781*8T1104K000	

1) Closer tolerances on request.

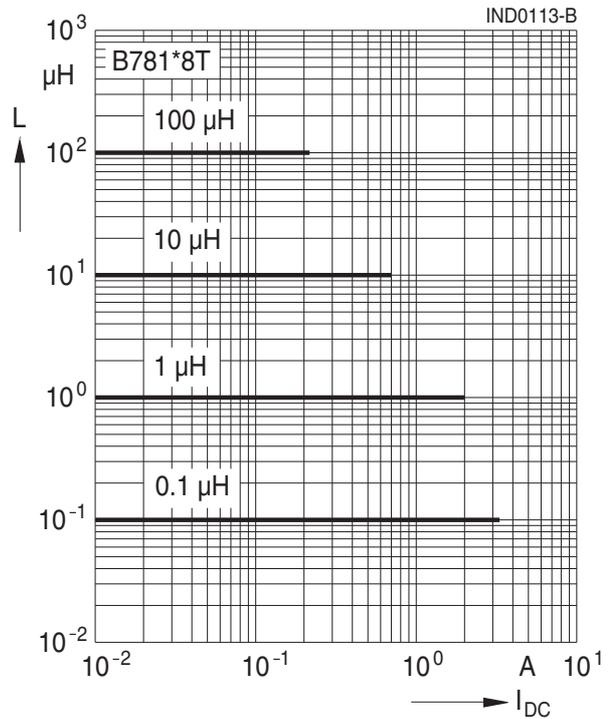
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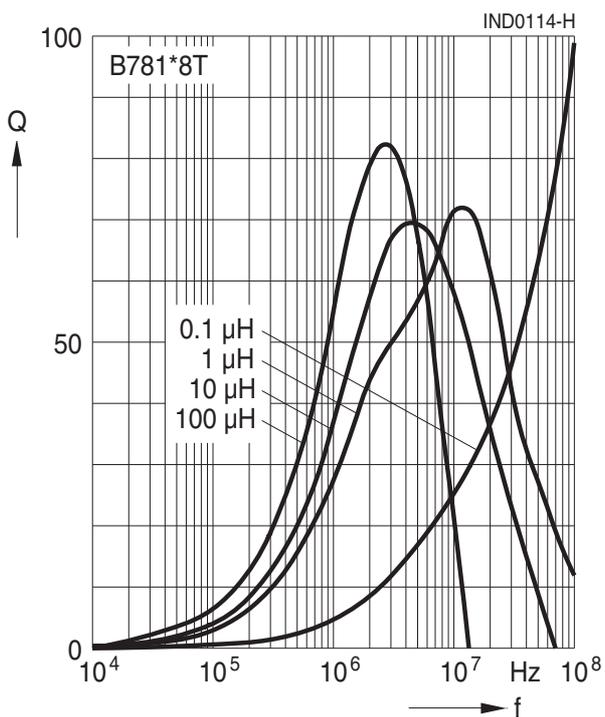
Impedance $|Z|$ versus frequency f
 measured with impedance analyzer Agilent 4294A or S-parameter network analyzer Agilent 8753ES, typical values at +20 °C



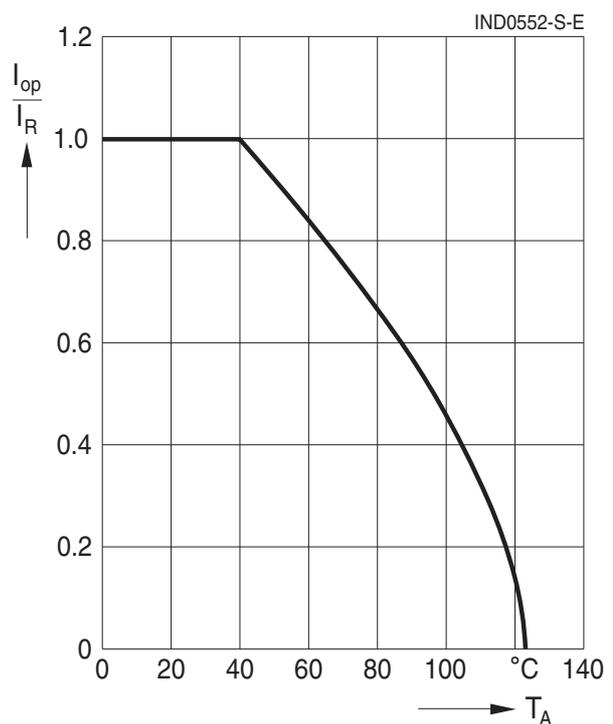
Inductance L versus DC load current I_{DC}
 measured with LCR meter Agilent 4284A, typical values at +20 °C



Q factor versus frequency f
 measured with impedance analyzer Agilent 4294A, typical values at +20 °C



Current derating I_{op}/I_R versus ambient temperature T_A
 (rated temperature $T_R = +40$ °C)



Cautions and warnings

- Please note the recommendations in our Inductors data book (latest edition) and in the data sheets.
 - Particular attention should be paid to the derating curves given there.
 - The soldering conditions should also be observed. Temperatures quoted in relation to wave soldering refer to the pin, not the housing.
- If the components are to be washed varnished it is necessary to check whether the washing varnish agent that is used has a negative effect on the wire insulation, any plastics that are used, or on glued joints. In particular, it is possible for washing varnish agent residues to have a negative effect in the long-term on wire insulation.
Washing processes may damage the product due to the possible static or cyclic mechanical loads (e.g. ultrasonic cleaning). They may cause cracks to develop on the product and its parts, which might lead to reduced reliability or lifetime.
- The following points must be observed if the components are potted in customer applications:
 - Many potting materials shrink as they harden. They therefore exert a pressure on the plastic housing or core. This pressure can have a deleterious effect on electrical properties, and in extreme cases can damage the core or plastic housing mechanically.
 - It is necessary to check whether the potting material used attacks or destroys the wire insulation, plastics or glue.
 - The effect of the potting material can change the high-frequency behaviour of the components.
- Ferrites are sensitive to direct impact. This can cause the core material to flake, or lead to breakage of the core.
- Even for customer-specific products, conclusive validation of the component in the circuit can only be carried out by the customer.

Important notes

The following applies to all products named in this publication:

1. Some parts of this publication contain **statements about the suitability of our products for certain areas of application**. These statements are based on our knowledge of typical requirements that are often placed on our products in the areas of application concerned. We nevertheless expressly point out **that such statements cannot be regarded as binding statements about the suitability of our products for a particular customer application**. As a rule we are either unfamiliar with individual customer applications or less familiar with them than the customers themselves. For these reasons, it is always ultimately incumbent on the customer to check and decide whether a product with the properties described in the product specification is suitable for use in a particular customer application.
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